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Specification						
Part Number: MC2			605F6WE-SPTLY			
Vers	Version: 3		3			
Date	e:	30/09	30/09/2014			
		Revis	sion			
0	2011/09/23		First issue			
Α	2012/09/06		Modify VOP			
В	2014/09/30		Remove IC information			

design • manufacture • supply



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### 1.General Specification

The Features is described as follow:

■ Module dimension: 59.0 x 29.3 x 5.5 (max.) mm

■ View area: 52.0 x 15.0 mm

Active area: 46.7 x 9.84 mm

■ Number of Characters: 16 characters x 2 Lines

■ Dot size: 0.45 x 0.54 mm

■ Dot pitch: 0.50 x 0.59 mm

■ Character size: 2.45 x 4.67 mm

■ Character pitch: 2.95 x 5.17 mm

■ LCD type: STN Positive, Yellow Green Transflective,

■ Duty: 1/16

■ View direction: 6 o'clock

■ Backlight Type: LED, Yellow Green

■ IC: ST7066Ugn • manufacture • supply

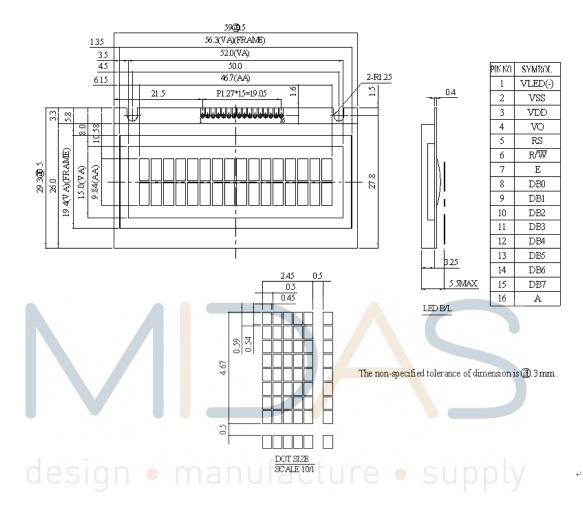
#### **Midas LCD Part Number System**

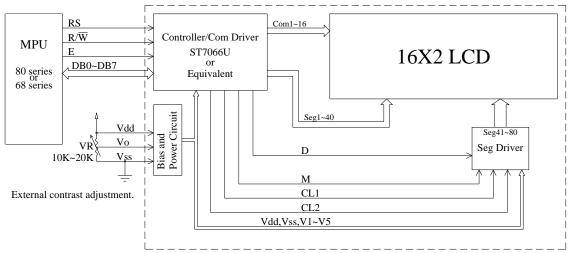
```
MC COG 132033
                                                   6
                                                                                       S
                                                                                                      Т
                                                                                                              L
            2
   1
                         3
                                    4
                                           5
                                                   6
                                                          7
                                                                                                     12
                                                                                                             13
                                                                 8
                                                                         9
                                                                                      10
                                                                                             11
                                                                                                                     14
                                                                                                                             15
                                                                                                                                    16
                    MC: Midas Components
                    Blank: COB (chip on board)
                                                  COG: chip on glass
3
                    No of dots
                                        (e.g. 240064 = 240 \times 64 \text{ dots}) (e.g. 21605 = 2 \times 16 \text{ 5mm C.H.})
                    Series
                    Series Variant:
                                        A to Z - see addendum
5
                    3: 3 o'clock
                                        6: 6 o'clock
                                                            9: 9 o'clock
                                                                                 12: 12 o'clock
                    S: Normal (0 to + 50 deg C) W: Wide temp. (-20 to + 70 deg C) X: Extended temp (-30 + 80 Deg C)
7
8
                    Character Set
                    Blank: Standard (English/Japanese)
                    C: Chinese Simplified (Graphic Displays only)
                    CB: Chinese Big 5 (Graphic Displays only)
                    H: Hebrew
                    K: European (std) (English/German/French/Greek)
                    L: English/Japanese (special)
                    M: European (English/Scandinavian)
                    R: Cyrillic
                    W: European (English/Greek)
                    U: European (English/Scandinavian/Icelandic)
                    ]: Asian/Arabic
                    Bezel Height (where applicable / available)
                                Top of Bezel to Top of
                                                         Common (via
                                                                         Array or
                                        PCB
                                                         pins 1 and 2)
                                                                         Edge Lit
                      Blank
                               9.5mm / not applicable
                                                           Common
                                                                          Array
                      2
                               8.9 mm
                                                           Common
                                                                          Array
                      3
                               7.8 mm
                                                           Separate
                                                                          Array
                       4
                               7.8 mm
                                                           Common
                                                                          Array
                                                                          Array
                      5
                               9.5 mm
                                                           Separate
                       6
                               7 mm
                                                           Common
                                                                          Array
                      7
8
                                                           Separate
                                                                          Array
                               7 mm
                                                           Common
                                                                           Edge
                               6.4 mm
                       9
                               6.4 mm
                                                           Separate
                                                                           Edge
                       Α
                               5.5 mm
                                                           Common
                                                                           Edge
                                                           Separate
                      В
                                                                           Edge
                               5.5 mm
                      D
                               6.0mm
                                                           Separate
                                                                           Edge
                      Е
                                                                           Edge
                                                           Separate
                               5.0mm
                      F
                               4.7mm
                                                           Common
                                                                           Edge
                       G
                               3.7mm
                                                           Separate
10
                    T: TN S: STN B: STN Blue G: STN Grey F: FSTN F2: FFSTN Z: Zero Power (Bi-Stable)
                    P: Positive N: Negative
11
                    R: Reflective M: Transmissive T: Transflective
12
                    Backlight: Blank: Reflective L: LED
13
                    Backlight Colour:
                                        Y: Yellow-Green W: White B: Blue R: Red A: Amber O: Orange G: Green RGB: R.G.B.
14
                    If Z (Zero Power):
                                        WB: White on blue GB: Green on black YB: Yellow on black YPB: Yellow on pink and/or blue
                    Driver Chip:
                                                            1: 1°C T: Toshiba T6963C A: Avant SAP1024B
                                        Blank: Standard
15
16
                    Voltage Variant: e.g. 3 = 3v
```

### 3.Interface Pin Function

Pin No.	Symbol	Level	Description
1	VLED(-)	_	Power supply for B/L(-)
2	Vss	0V	Ground
3	$V_{DD}$	5.0V	Supply Voltage for logic
4	Vo	(Variable)	Operating voltage for LCD
5	RS	H/L	H: DATA, L: Instruction code
6	R/W	H/L	H: Read (Module> MPU) L: Write(MPU> Module)
7	E	H/L	Chip enable signal
8	DB0	H/L	Data bus line
9	DB1	H/L	Data bus line
10	DB2	H/L	Data bus line
11	DB3	H/L	Data bus line
12	DB4	H/L	Data bus line
13	DB5	H/L	Data bus line
14	DB6	H/L	Data bus line
15	DB7	H/L	Data bus line
16	А	_	LED+

## 4. Contour Drawing & Block Diagram





Character located DDRAM address DDRAM address

1 2 3 4 5 6 7 8 9 10 11 12 13 14 15 16 00 01 02 03 04 05 06 07 08 09 0A 0B 0C 0D 0E 0F 40 41 42 43 44 45 46 47 48 49 4A 4B 4C 4D 4E 4F

### **5.Character Generator ROM Pattern**

Table.2

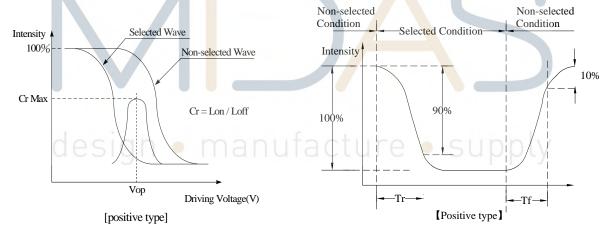
Upper 4 bit																
Lower 4 bit	LLLL	LLLH	LLHL	LLHH	LHLL	LHLH	LHHL	LHHH	HLLL	HLLH	HLHL	HLHH	HHLL	HHLH	HHHL	нннн
LLLL	CG RAM (1)	[					==	<b>!</b>			-:::	=	<b>!</b>			··
LLLH	CG RAM (2)			i.		][	-::::		· . •.,.•[		**		-,!		*===	i:
LLHL	CG RAM (3)		11					i			=	-:-	=[=[=		=====	
LLHH	CG RAM (4)					-,,,,	1	-:::-	-:::	=====	   		=====		<b>!!!!</b>	
LHLL	CG RAM (5)			===				*****		=====		-	-1:-!			
LHLH	CG RAM (6)	I.		1		<b>!!</b>		1[						:::1	77	
LHHL	CG RAM (7)	*				II		1.,.1	-2011			1.1	[			<b>!!!</b>
LHHH	CG RAM (8)			=======================================			-::::	II	*****			:-:	[	: ::	1	==
HLLL	CG RAM (1)	es	sig	n:		me	111	) fie		U.	Έ	•	BÜ!	эp	ly:	
HLLH	CG RAM (2)	••		}		1,,1		-:::			-	-:-			.="=.	-17-1
HLHL	CG RAM (3)			==		=====						-:-			<b></b>	
нгнн	CG RAM (4)			::			<b>!-:</b> .	====		;		-::::		="="=	1,.:	
HHLL	CG RAM (5)		==	•:-		****						]:::-			====	
HHLH	CG RAM (6)	a"a_a									======		==			
нннг	CG RAM (7)		==			"	<b>!</b> !	***,*							<b></b>	
нннн	CG RAM (8)						! <b>!</b>	:::::		===-	-::::			<b>!</b> !.	:!·	

### **6.Optical Characteristics**

Item	Symbol	Condition	Min	Тур	Max	Unit
	θ	CR <b>≧</b> 2	0	_	20	ψ= 180°
View Angle	θ	CR <b>≧</b> 2	0	_	40	ψ= 0°
View Angle	θ	CR≧2	0	_	30	ψ= 90°
	θ	CR <b>≧</b> 2	0	_	30	ψ= 270°
Contrast Ratio	CR	_	_	3	_	_
D Time	T rise	_	_	150	200	ms
Response Time	T fall	_	_	150	200	ms

**Definition of Operation Voltage (Vop)** 

Definition of Response Time (Tr, Tf)

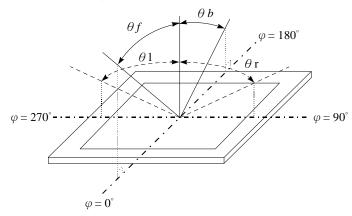


#### **Conditions:**

Operating Voltage : Vop Viewing Angle( $\theta$ ,  $\phi$ ) :  $0^{\circ}$ ,  $0^{\circ}$ 

Frame Frequency: 64 HZ Driving Waveform: 1/N duty, 1/a bias

#### Definition of viewing angle(CR≥2)



## 7. Absolute Maximum Ratings

Item	Symbol	Min	Тур	Max	Unit
Operating Temperature	Тор	-20	_	+70	
Storage Temperature	Тѕт	-30	_	+80	
Input Voltage	Vı	Vss	_	V <sub>DD</sub>	V
Supply Voltage For Logic	VDD-Vss	-0.3	_	7	V
Supply Voltage For LCD	V <sub>DD</sub> -V <sub>o</sub>	-0.3	_	13	V



#### **8. Electrical Characteristics**

Item	Symbol	Condition	Min	Тур	Max	Unit
Supply Voltage For Logic	V <sub>DD</sub> -V <sub>SS</sub>	_	4.5	5.0	5.5	<b>V</b>
Supply Voltage For LCD		Ta=-20	_	_	_	V
*Note	$V_{DD}$ - $V_0$	Ta=25	3.6	3.7	3.8	V
		Ta=70	_	_	_	V
Input High Volt.	Vıн	_	0.7 V <sub>DD</sub>	_	V <sub>DD</sub>	V
Input Low Volt.	VıL	_	Vss	_	0.6	V
Output High Volt.	Vон	_	3.9	_	V <sub>DD</sub>	V
Output Low Volt.	Vol		0	-	0.4	V
Supply Current	IDD	V <sub>DD</sub> =5.0V	1.0	1.2	1.5	mA

<sup>\*</sup> Note: Please design the VOP adjustment circuit on customer's main board



### 9.Backlight Information

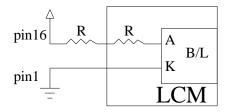
#### **Specification**

PARAMETER	SYMBOL	MIN	TYP	MAX	UNIT	TEST CONDITION
Supply Current	ILED	32	40	60	mA	V=5.0V
Supply Voltage	V	4.9	5.0	5.1	V	_
Reverse Voltage	VR	_	_	8	V	_
Luminance	IV	37.28	46.6	_	CD/M <sup>2</sup>	ILED=40mA
(Without LCD)						
Life Time	Al		50000	_	Hr.	V <b>≦</b> 5.0V
Color			Y	ellow (	Green	

Note: The LED of B/L is drive by current only, drive voltage is for reference only.

drive voltage can make driving current under safety area (current between minimum and maximum).

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Drive from pin1,pin16



(Will never get Vee output from pin16)

#### 10.Reliability

#### Content of Reliability Test (Wide temperature, -20 ~70 )

	Environmental Test		
Test Item	Content of Test	Test Condition	Note
High Temperature storage	Endurance test applying the high storage temperature for a long time.	80 200hrs	2
Low Temperature storage	Endurance test applying the low storage temperature for a long time.	-30 200hrs	1,2
High Temperature Operation	Endurance test applying the electric stress (Voltage & Current) and the thermal stress to the element for a long time.	70 200hrs	
Low Temperature Operation	Endurance test applying the electric stress under low temperature for a long time.	-20 200hrs	1
High Temperature/ Humidity storage	The module should be allowed to stand at 60 ,90%RH max For 96hrs under no-load condition excluding the polarizer, Then taking it out and drying it at normal temperature.	60 ,90%RH 96hrs	1,2
Thermal shock resistance	The sample should be allowed stand the following 10 cycles of operation -20 25 70	-20 /70 10 cycles	
Vibration test	Endurance test applying the vibration during transportation and using.	Total fixed amplitude:  1.5mm  Vibration Frequency:  10~55Hz  One cycle 60 seconds to 3 directions of X,Y,Z for Each 15 minutes	3
Static electricity test	Endurance test applying the electric stress to the terminal.	VS=800V,RS=1.5kΩ CS=100pF 1 time	

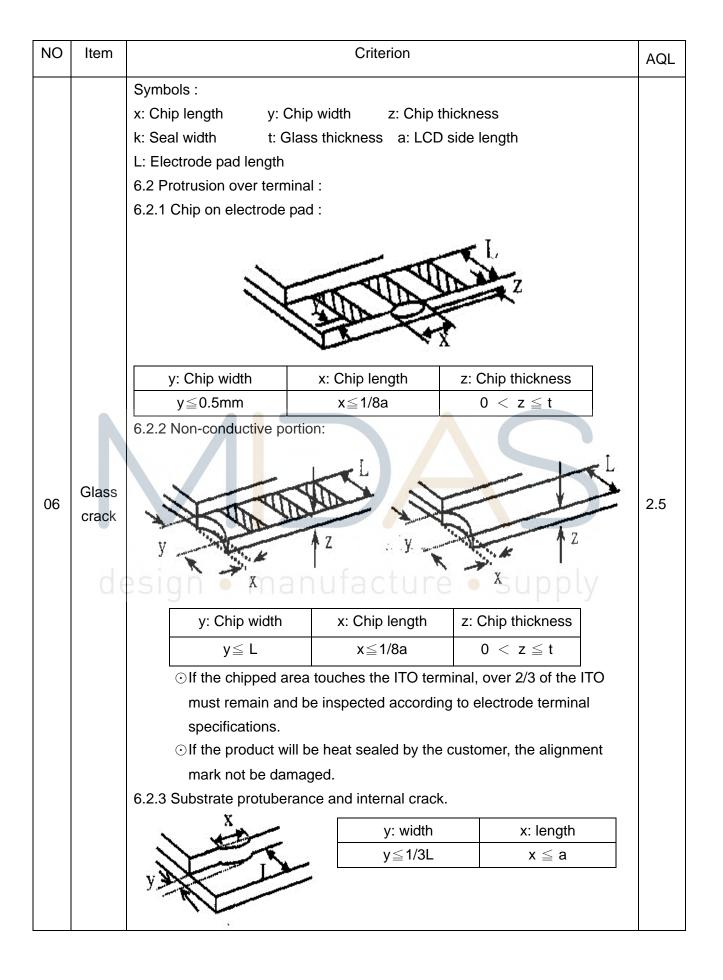
Note1: No dew condensation to be observed.

Note2: The function test shall be conducted after 4 hours storage at the normal Temperature and humidity after remove from the test chamber.

Note3: The packing have to including into the vibration testing.

# 11.Inspection specification

NO	Item	Criterion						
01	Electrical Testing	<ul> <li>1.1 Missing vertical, horizontal segment, segment contrast defect.</li> <li>1.2 Missing character, dot or icon.</li> <li>1.3 Display malfunction.</li> <li>1.4 No function or no display.</li> <li>1.5 Current consumption exceeds product specifications.</li> <li>1.6 LCD viewing angle defect.</li> <li>1.7 Mixed product types.</li> <li>1.8 Contrast defect.</li> </ul>						
02	Black or white spots on LCD (display only)	three white o	<ul><li>2.1 White and black spots on display ≤0.25mm, no more than three white or black spots present.</li><li>2.2 Densely spaced: No more than two spots or lines within 3mm</li></ul>					
03	LCD black spots, white spots, contamination (non-display)	3.1 Round type $\Phi = (x + y) / A$ $A = (x + y) / A$ 3.2 Line type : (A)	2 1 Y	$Φ \le 0.10$ $0.10 < Φ \le 0.20$ $0.20 < Φ \le 0.25$ $0.25 < Φ$	Acceptable Q TY Accept no dense 2 1 0 Acceptable Q TY	2.5		
		→ı L +	Length L≦3.0 L≦2.5	$\begin{array}{c} \text{Width} \\ \text{W} \! \leq \! 0.02 \\ \text{0.02} \! < \! \text{W} \! \leq \! 0.03 \\ \text{0.03} \! < \! \text{W} \! \leq \! 0.05 \\ \text{0.05} \! < \! \text{W} \end{array}$	Accept no dense  2  As round type	2.5		
04	Polarizer bubbles	If bubbles are vi judge using blace specifications, no to find, must che specify direction	ck spot ot easy eck in	Size Φ $Φ \le 0.20$ $0.20 < Φ \le 0.50$ $0.50 < Φ \le 1.00$ $1.00 < Φ$ Total Q TY	Acceptable Q TY Accept no dense 3 2 0 3	2.5		



NO	Item	Criterion	AQL
07	Cracked glass	The LCD with extensive crack is not acceptable.	2.5
08	Backlight elements	<ul> <li>8.1 Illumination source flickers when lit.</li> <li>8.2 Spots or scratched that appear when lit must be judged.</li> <li>Using LCD spot, lines and contamination standards.</li> <li>8.3 Backlight doesn't light or color wrong.</li> </ul>	0.65 2.5 0.65
09	Bezel	<ul><li>9.1 Bezel may not have rust, be deformed or have fingerprints, stains or other contamination.</li><li>9.2 Bezel must comply with job specifications.</li></ul>	2.5 0.65
10	PCB · COB desig	<ul> <li>10.1 COB seal may not have pinholes larger than 0.2mm or contamination.</li> <li>10.2 COB seal surface may not have pinholes through to the IC.</li> <li>10.3 The height of the COB should not exceed the height indicated in the assembly diagram.</li> <li>10.4 There may not be more than 2mm of sealant outside the seal area on the PCB. And there should be no more than three places.</li> <li>10.5 No oxidation or contamination PCB terminals.</li> <li>10.6 Parts on PCB must be the same as on the production characteristic chart. There should be no wrong parts, missing parts or excess parts.</li> <li>10.7 The jumper on the PCB should conform to the product characteristic chart.</li> <li>10.8 If solder gets on bezel tab pads, LED pad, zebra pad or screw hold pad, make sure it is smoothed down.</li> <li>10.9 The Scraping testing standard for Copper Coating of PCB</li> </ul>	2.5 2.5 0.65 2.5 0.65 2.5 2.5
11	Soldering	<ul> <li>11.1 No un-melted solder paste may be present on the PCB.</li> <li>11.2 No cold solder joints, missing solder connections, oxidation or icicle.</li> <li>11.3 No residue or solder balls on PCB.</li> <li>11.4 No short circuits in components on PCB.</li> </ul>	2.5 2.5 2.5 0.65

NO	Item	Criterion	AQL
		12.1 No oxidation, contamination, curves or, bends on interface Pin (OLB) of TCP.	2.5
		12.2 No cracks on interface pin (OLB) of TCP.	0.65
		12.3 No contamination, solder residue or solder balls on product.	2.5
		12.4 The IC on the TCP may not be damaged, circuits.	2.5
		12.5 The uppermost edge of the protective strip on the interface	2.5
		pin must be present or look as if it cause the interface pin to	
12	General appearance	sever.  12.6 The residual rosin or tin oil of soldering (component or chip	2.5
	appearance	component) is not burned into brown or black color.	2.5
		12.7 Sealant on top of the ITO circuit has not hardened.	0.65
		12.8 Pin type must match type in specification sheet.	0.65
		12.9 LCD pin loose or missing pins.	0.65
		12.10 Pr <mark>od</mark> uct packaging must the <mark>same a</mark> s specified on	
		packaging specification sheet.	0.65
	IV	12.11 Product dimension and structure must conform to product specification sheet.	
		12.12 Visual defect outside of VA is not considered to be rejection.	

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#### 12.Precautions in use of LCD Modules

- (1)Avoid applying excessive shocks to the module or making any alterations or modifications to it.
- (2)Don't make extra holes on the printed circuit board, modify its shape or change the components of LCD module.
- (3)Don't disassemble the LCM.
- (4)Don't operate it above the absolute maximum rating.
- (5)Don't drop, bend or twist LCM.
- (6) Soldering: only to the I/O terminals.
- (7) Storage: please storage in anti-static electricity container and clean environment.
- (8) Midas have the right to change the passive components, including R3,R6 & backlight adjust resistors. (Resistors, capacitors and other passive components will have different appearance and color caused by the different supplier.)
- (9) Midas have the right to change the PCB Rev. (In order to satisfy the supplying stability, management optimization and the best product performance...etc, under the premise of not affecting the electrical characteristics and external dimensions, Midas have the right to modify the version.)

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#### 13. Material List of Components for RoHs

1. Midas hereby declares that all of or part of products (with the mark "#"in code), including, but not limited to, the LCM, accessories or packages, manufactured and/or delivered to your company (including your subsidiaries and affiliated company) directly or indirectly by our company (including our subsidiaries or affiliated companies) do not intentionally contain any of the substances listed in all applicable EU directives and regulations, including the following substances.

Exhibit A: The Harmful Material List

Material	(Cd)	(Pb)	(Hg)	(Cr6+)	PBBs	PBDEs
Limited	100	1000	1000	1000	1000	1000
Value	ppm	ppm	ppm	ppm	ppm	ppm
Above limited value is set up according to RoHS.						

#### 2.Process for RoHS requirement:

- (1) Use the Sn/Ag/Cu soldering surface; the surface of Pb-free solder is rougher than we used before.
- (2) Heat-resistance temp. :

anutacture • supply Reflow: 250 .30 seconds Max.

Connector soldering wave or hand soldering: 320, 10 seconds max.

(3) Temp. curve of reflow, max. Temp. : 235±5

Recommended customer's soldering temp. of connector: 280, 3 seconds.

### 14. Recommendable Storage

- 1. Place the panel or module in the temperature 25°C±5°C and the humidity below 65% RH
- 2. Do not place the module near organics solvents or corrosive gases.
- 3. Do not crush, shake, or jolt the module.

